

High Performance Probe Head for High Volume Production Test



Automotive / Power



Mobility



Precision Analog / Sensors

Benefits

- Allows testing of RF devices at the wafer-level
- Adaptable to wafer-level probing and singulated device testing for debug and characterization
- Long life and extended maintenance intervals
- Engineering analysis of WLCSP devices or KGD
- Consistently high test yields
- Maximum mechanical operating window to overcome z-stack non-coplanarity

Key Features

- Low loop inductance and high bandwidth
- Device pitches down to 100 µm
- Variety of contact and body materials to optimize performance
- Manual actuation of singulated devices
- Low and stable contact resistance
- Individual probe compliance with large mechanical overdrive



High End Digital



RF

- Wafer probe solution down to 100 μm pitch
- Up to 27 GHz @ -1 dB

- Field replaceable individual probes
- Life cycle up to 1M



A Cohu

cViper Probe Head



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Specifications

Packages and Applications

- WLCSP
- Singulated devices, wafer probe, or wafer-level test
- Pitches down to 0.1 mm

Environmental

- Temperature Range
 - VIP010: -55 °C to +100 °C
 - VIP015: -55 °C to +125 °C
 - VIP020: -55 °C to +155 °C

Reliability*

- 500,000 cycles for packaged device
- 1M cycles for WLCSP Test
- Probe cleaning 20,000 to 50,000

Electrical

- Bandwidth @ -1 dB
 - VIPo10: TBD**
 - VIPo15: up to 44 GHz*
 - VIPo20: 30 GHz
- Loop Inductance
 - VIPo10: TBD**
 - VIP015: down to 1.15 nH*
 - VIP020: 1.27 nH
- Contact Resistance
 - VIP010: 450 mΩ
 - VIP015: 280 mΩ
 - VIPo20: 220 mΩ
- ISMI Current Rating
 - VIP010: 0.95 A
 - VIP015: 0.83 A
 - VIP020: 1.26 A

Mechanical

Contact Pitches Supported

o.1 mm and up

- VIP015: 250 μm
 - VIPo20: 200 μm

• VIP010: 4.3 mm

• VIP015: 4.3 mm

• VIPo20: 3.9 mm

DUT Side Compliance

VIP010: 200 μm

• DUT Tip Style

Test Height

• VIPo10: B (single point)

Contact Force at Test Height
VIP010: 0.04 N (3.9 gf)
VIP015: 0.06 N (5.9 gf)

• VIPo20: 0.05 N (5.5 qf)

- VIPo15: L (four-point crown)
- VIPo20: L (four-point crown)
- PCB Tip Style
 - VIPo10: single point
 - VIP015: radius
 - VIPo20: radius

Materials

- Housing Material
 - MDS-100
 - Ceramic
 - Photoveel[®]
 - Other materials available upon request
- Spring Probe DUT Tip Plating
 - PD alloy
- Spring Material
 - VIPo10: proprietary high-temperature alloy
 - VIPo15: proprietary high-temperature alloy
 - VIPo20: stainless steel

Configurations / Interface Options

- Automated test Customer-specific design / configuration
- Optional manual actuator with alignment frame or FAP. Allows post-singulation contact

* Actual values are dependent on the application (DUT materials, maintenance, etc.) ** Data will be released at a later date.

All specifications are subject to change without notification and are for reference only. Use contactor drawing to design interface hardware. For detailed performance specifications, please contact Cohu.

REV20200928

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